HAT2036R

Silicon N Channel Power MOS FET Power Switching

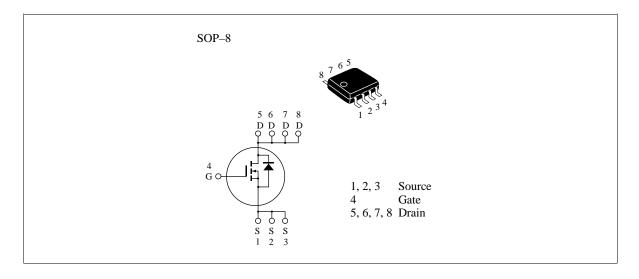
HITACHI

ADE-208-665D (Z) 5th. Edition Feb. 1999

Features

- Low on-resistance $R_{DS(on)}=12m$ typ
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- High speed switching tf=60ns typ.

Outline





HAT2036R

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	30	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	I _D	12	Α	
Drain peak current	I _{D(pulse)} *1	96	Α	_
Body-drain diode reverse drain current	I _{DR}	12	Α	
Channel dissipation	Pch*2	2.5	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

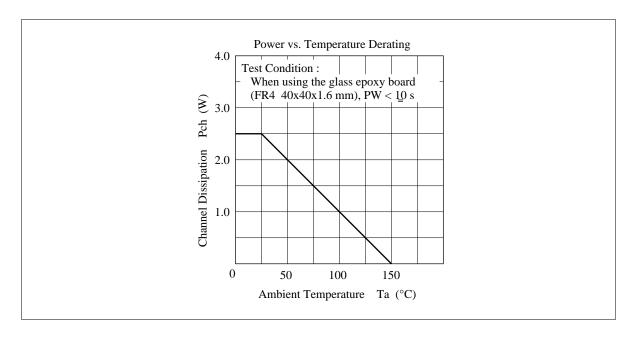
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_{D} = 10 \text{mA}, V_{GS} = 0$
Gate to source leak current	$I_{\rm GSS}$	_	_	±0.1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.5	_	3.0	V	$V_{DS} = 10V$, $I_D = 1mA$
Static drain to source on state	$R_{\text{DS(on)}}$	_	12	15	$m\Omega$	$I_D = 6A, V_{GS} = 10V^{*1}$
resistance	R _{DS(on)}	_	20	30	$m\Omega$	$I_D = 6A, V_{GS} = 4.5V^{*1}$
Forward transfer admittance	y _{fs}	12	20	_	S	$I_D = 6A, V_{DS} = 10V^{*1}$
Input capacitance	Ciss	_	1200	_	pF	V _{DS} = 10V
Output capacitance	Coss	_	380	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	200	_	pF	f = 1MHz
Total gate charge	Qg	_	23	_	nc	$V_{DD} = 10V$
Gate to source charge	Qgs	_	4.0	_	nc	V _{GS} = 10V
Gate to drain charge	Qgd	_	6.0	_	nc	I _D = 12A
Turn-on delay time	$t_{d(on)}$	_	40	_	ns	$V_{GS} = 4.5V, I_{D} = 6A$
Rise time	t _r	_	300	_	ns	$V_{DD} \approx 10V$
Turn-off delay time	$\mathbf{t}_{\text{d(off)}}$	_	35	_	ns	
Fall time	t _f	_	60	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.9	_	V	IF = 12A, V _{GS} = 0 *1
Body-drain diode reverse recovery time	t _{rr}		35		ns	IF = 12A, $V_{GS} = 0$ diF/ dt =20A/µs

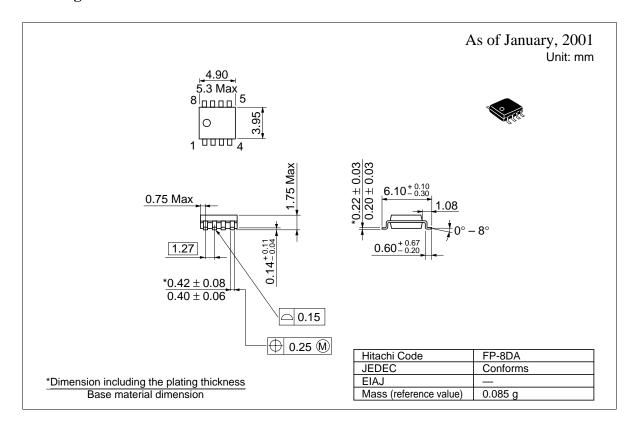
Note: 1. Pulse test

Main Characteristics



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Package Dimensions



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